

University of Engineering & Technology Mardan Campus, Pakistan

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ogram:	B.Sc. Electrical Engg.							-	
an:	Power Major		СН	Grade	Code	Title		СН	Grad
ode	Title		OII	Orace		E 11 0040			
	Fall 2017					Fall 2019		3.00	В-
SSI 122	Calculus	(RPT)	* 3.00	C-	BSI 362	Complex Variables & FT		3.00	В
SI 122	Provessional Ethics		2.00	C-	EE 336	Electrical Measurements		1.00	C+
SI 151	Electricity & Magnetism		3.00	C+	EE 336L	Electrical Measurements		3.00	B+
SI 151L	Electricity & Magnetism		1.00	C	EE 363	Electromagnetic Field Theory		3.00	C+
SI 101	Islamic Studies		2.00	В	EE 346	Electronics Circuit-II		1.00	B-
EE 121	Computer Fundamentals	(RPT	2.00	F	EE 346L	Electronics Circuit-II		3.00	В
	Electrical Engineering Drawing		1.00	B-	EE 287	Engineering Economics	(RPT)*		C-
ME 100	Computer Fundamentals		1.00	A-	EE 305	Power Electronics	(RPT)*	3.00	D
EE 121L	Eng Composition &Comprehensi	on (RPT	3.00	F	EE 305L	Power Electronics		1.00	D
3SI 132		SGPA: 2.47				SCH: 18.00 SGP: 48.99	SGPA: 2.72		
	SCH: 10.00 SGP: 24.67 CCH: 10.00 CGP: 24.67	CGPA: 2.47				CCH: 80.00 CGP: 232.02	CGPA: 2.90		
	COII. 10.00					Spring 2020			
	Spring 2018		la	In.	EE 312	Signals & Systems	- men , my	3.00	В
BSI 111	Linear Algebra		3.00		EE 312L	Signals & Systems		1.00	
EE 156	Basic Electrical Engineering		3.00	The state of the s	FF 286	Technical Report Writing		3.00	A-
EE 156L	Basic Electrical Engineering		1.00	200		Engineering Management		2.00	
EE 170	Computer Programming		3.00		EE 388	Communication Systems		3.00	В
EE 170L	Computer Programming		1.00		EE 391	Communication Systems		1.00	
BSI 162	Engineering Mechanics		3.00		EE 391L	Communication Systems		3.00	C. 12000
EE 157	Workshop Technology		1.00		CE 303	Hydraulics		3.00	2 100
EE 157L	Workshop Technology		1.0	0 C-	EE 205	Power Generation & Utilization	SGPA: 3.11	0.00	
BSI 110	Pak Studies		2.0	0 B		SCH: 19.00 SGP: 59.01 CCH: 99.00 CGP: 291.03	CGPA: 2.94		
001 110	SCH: 18.00 SGP: 52.66	SGPA: 2.93	-/-	1	N A	CCH: 99.00 CGP: 291.03	COF A. 2.04		
	CCH: 28.00 CGP: 77.33	CGPA: 2.76				Summer 2020			
	S				BSI 122	Calculus	(RPT)*	3.00	
	Summer 2018		- la a	. 10	1 EE 326	Micropro, Based System Design	n (RPT)*	3.00) A-
EE 121	Computer Fundamentals	(RP	T)* 2.0	0 C-		SCH: 6.00 SGP: 22.02	SGPA: 3.67		
	SCH: 2.00 SGP: 3.34	SGPA: 1.67	- 100			CCH: 105.00 CGP: 313.05	CGPA: 2.98		
	CCH: 30.00 CGP: 80.67	CGPA: 2.69				Fall 2020			
	Fall 2018				EE 440	Electrical Machines		3.00) B-
	Differential Equations	100	3.0	00 B-		Electrical Machines		1.00	B
BSI 231		(RP	200	1200	EE 440L			3.00	0 B-
EE 119	Digital Logic & Design	(RF		No. of the last of	EE 410	Renewable Energy		3.0	0 B
EE 200	Circuit Analysis-I	lixi	3.0		EE 403	Power system Analysis	_	1.0	
ME 209	Applied Thermodynamics	(RF	778	1000	EE 403L	Power System Analysis	SGPA: 2.94	1.10	
BSI 143	Comm & Presentation Skills		30 Miles			SCH: 11.00 SGP: 32.33 CCH: 116.00 CGP: 345.38	CGPA: 2.98		
BSI 132	Eng Composition &Comprehen	SION (Kr	1.0		180	CCH: 116.00 CGP: 345.38	CGFA. 2.30	-	-
EE 119L	Digital Logic & Design		2000	00 B	VV	Spring 2021			
EE 200L	Circuit Analysis-I		1.	00 0	EE 401	Power Transmission & Distribu	t	3.0	
Contract of	SCH: 11.00 SGP: 35.01	SGPA: 3.18 CGPA: 2.82			EE 481L	Control Systems		1.0	
	CCH: 41.00 CGP: 115.68	CGPA: 2.82			EE 406	Power System Protection		3.0	00 B
	Spring 2019				EE 481	Control Systems		3.0	00 B
	Prob. & Random Variables		3.	00 B-	EE 481	Project		6.0	00 A
FF 000				00 D+	EE 4/0	SCH: 16.00 SGP: 51.02	SGPA: 3.19		
EE 202	Misropro Based System Desig	in (R		00 B+		CCH: 132.00 CGP: 396.40	CGPA: 3.00		
EE 326	Micropro. Based System Desig	in (R	3.				A CONTRACTOR OF THE PARTY OF TH	Time!	
EE 326 EE 201	Micropro. Based System Desig Circuit Analysis-II	in (Ri	1 1 2 2	.00 A-					
EE 326 EE 201 BSI 242	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis	ın (R	3.	CONTRACTOR OF THE PARTY OF THE		Summer 2021			
EE 326 EE 201 BSI 242 EE 345	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits	ın (R	3.	.00 A-	EE 305	Power Electronics	(RPT)		
EE 326 EE 201 BSI 242 EE 345 EE 201L	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits Circuit Analysis-II		3.	00 A- 00 B- 00 B-			(RPT)		
EE 326 EE 201 BSI 242 EE 345 EE 201L EE 326L	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits Circuit Analysis-II Micropro. Based System Desig		3. 3. 1. 1.	00 A- 00 B- 00 B-	EE 305 BSI 143	Power Electronics Comm & Presentation Skills SCH: 6.00 SGP: 20.01	(RPT) (RPT) SGPA: 3.34		
EE 326 EE 201 BSI 242 EE 345 EE 201L	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits Circuit Analysis-II Micropro. Based System Desig Electronic Devices & Circuits	gn	3. 3. 1. 1.	00 A- 00 B- 00 B-		Power Electronics Comm & Presentation Skills	(RPT)		
EE 326 EE 201 BSI 242 EE 345 EE 201L EE 326L	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits Circuit Analysis-II Micropro. Based System Desig Electronic Devices & Circuits SCH: 15.00 SGP: 45.36	gn SGPA: 3.02	3. 3. 1. 1.	00 A- 00 B- 00 B-		Power Electronics Comm & Presentation Skills SCH: 6.00 SGP: 20.01	(RPT) (RPT) SGPA: 3.34		
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EE 326 EE 201 BSI 242 EE 345 EE 201L EE 326L	Micropro. Based System Desig Circuit Analysis-II Numerical Analysis Electronic Devices & Circuits Circuit Analysis-II Micropro. Based System Desig Electronic Devices & Circuits SCH: 15.00 SGP: 45.36	gn SGPA: 3.02 CGPA: 2.88	3. 3. 1. 1. 1.	000 A- 000 B- 000 B- 000 B- B- 000 B		Power Electronics Comm & Presentation Skills SCH: 6.00 SGP: 20.01	(RPT) (RPT) SGPA: 3.34		
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Transcript Prepared By: Transcript Checked By: Date of issue:

Controller of Examinations